



OPA512

Very-High Current—High Power OPERATIONAL AMPLIFIER

FEATURES

- WIDE SUPPLY RANGE: $\pm 10\text{V}$ to $\pm 50\text{V}$
- HIGH OUTPUT CURRENT: 15A Peak
- CLASS A/B OUTPUT STAGE:
Low Distortion
- VOLTAGE-CURRENT LIMIT PROTECTION
CIRCUIT
- SMALL TO-3 PACKAGE

APPLICATIONS

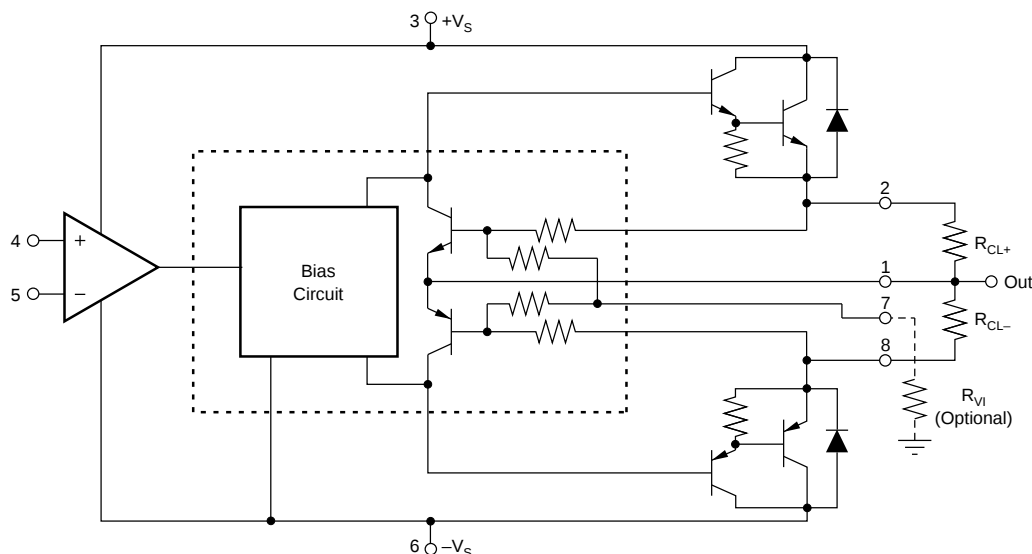
- SERVO AMPLIFIER
- MOTOR DRIVER
- SYNCRO EXCITATION
- AUDIO AMPLIFIER
- TEST PIN DRIVER

DESCRIPTION

The OPA512 is a high voltage, very-high current operational amplifier designed to drive a wide variety of resistive and reactive loads. Its complementary class A/B output stage provides superior performance in applications requiring freedom from cross-over distortion. User-set current limit circuitry provides protection to the amplifier and load in fault conditions. A resistor-programmable voltage-current limiter circuit may be used to further protect the amplifier from damaging conditions.

The OPA512 employs a laser-trimmed monolithic integrated circuit to bias the output transistors, providing excellent low-level signal fidelity and high output voltage swing. The reduced internal parts count made possible with this monolithic IC improves performance and reliability.

This hybrid integrated circuit is housed in a hermetic TO-3 package and all circuitry is electrically-isolated from the case. This allows direct mounting to a chassis or heat sink without cumbersome insulating hardware and provides optimum heat transfer.



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SPECIFICATIONS

ELECTRICAL

At $T_C = +25^\circ\text{C}$, and $V_S = \pm 40\text{V}$, unless otherwise noted.

PARAMETER	CONDITIONS	OPA512BM			OPA512SM			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
INPUT OFFSET VOLTAGE Initial Offset vs Temperature vs Supply Voltage vs Power	Specified Temp. Range		± 2 ± 10 ± 30 ± 20	± 6 ± 65 ± 200		± 1 * * *	± 3 ± 40 *	mV $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/\text{V}$ $\mu\text{V}/\text{V}$
INPUT BIAS CURRENT Initial vs Temperature vs Supply Voltage	Specified Temp. Range		12 ± 50 ± 10	30 400		10 * *	20 *	nA $\text{pA}/^\circ\text{C}$ pA/V
INPUT OFFSET CURRENT Initial vs Temperature	Specified Temp. Range		± 12 ± 50	± 30		± 5 *	± 10	nA $\text{pA}/^\circ\text{C}$
INPUT IMPEDANCE, DC			200			*		M Ω
INPUT CAPACITANCE			3			*		pF
VOLTAGE RANGE Common-Mode Voltage Common-Mode Rejection	Specified Temp. Range Specified Temp. Range	$\pm(V_S - 5)$ 74	$\pm(V_S - 3)$ 100		* *	* *		V dB
GAIN Open-Loop Gain at 10Hz Gain-Bandwidth Product, 1MHz Power Bandwidth Phase Margin	1k Ω Load Specified Temp. Range 8 Ω Load 8 Ω Load 8 Ω Load Specified Temp. Range 8 Ω Load	 96 13	110 108 4 20 20		 * * *	* * * *		dB dB MHz kHz Degrees
OUTPUT Voltage Swing ⁽¹⁾ Current, Peak Settling Time to 0.1% Slew Rate Capacitive Load	BM at 10A, SM at 15A Specified Temp. Range $I_O = 80\text{mA}$ $I_O = 5\text{A}$ 2V Step Specified Temp. Range G = 1 Specified Temp. Range G > 10	$\pm(V_S - 6)$ $\pm(V_S - 5)$ $\pm(V_S - 5)$ 10 2.5	 2 4	 1.5 SOA ⁽²⁾	$\pm(V_S - 7)$ * * 15 *	 * *		V V V A μs V/ μs nF
POWER SUPPLY Voltage Current, Quiescent	Specified Temp. Range	± 10	± 40 25	± 45 50	*	* *	± 50 35	V mA
THERMAL RESISTANCE AC Junction-to-Case ⁽³⁾ DC Junction-to-Case Junction to Air	$T_C = -55^\circ\text{C}$ to $+125^\circ\text{C}$, f > 60Hz $T_C = -55^\circ\text{C}$ to $+125^\circ\text{C}$ $T_C = -55^\circ\text{C}$ to $+125^\circ\text{C}$		0.8 1.25 30	0.9 1.4		* * *	* *	$^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$
TEMPERATURE RANGE Specified	T_C	-25		+85	-55		+125	$^\circ\text{C}$

*Specification same as OPA512BM.

NOTES: (1) $+V_S$ and $-V_S$ denote the positive and negative supply voltage, respectively. Total V_S is measured from $+V_S$ to $-V_S$. (2) SOA = Safe Operating Area.

(3) Rating applies if the output current alternates between both output transistors at a rate faster than 60Hz.

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OPA512

Supply Voltage, +V _S to -V _S	100V
Output Current: Source	15A
Sink	see SOA
Power Dissipation, Internal ⁽¹⁾	125W
Input Voltage: Differential	$\pm(V_S - 3V)$
Common-mode	$\pm V_S$
Temperature: Pins (soldering, 10s)	+30°C
Junction ⁽¹⁾	+200°C
Temperature Range: Storage ⁽²⁾	-65°C to +150°C
Operating (Case)	-55°C to +125°C

NOTES: (1) Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation to achieve high MTTF. (2) OPA512BM, -55°C to +100°C.

Top View

The diagram shows an 8-pin op-amp package with the following connections:

- Pin 1: Output, connected to a load resistor R_{CL} .
- Pin 2: +Current Limit.
- Pin 3: $+V_S$.
- Pin 4: -In.
- Pin 5: $-V_S$.
- Pin 6: -Current Limit.
- Pin 7: R_{VI} .
- Pin 8: -Current Limit.

The op-amp symbol is shown inside the package, with its non-inverting input (+) connected to pin 3 and its inverting input (-) connected to pin 4. The output of the op-amp is connected to pin 1.

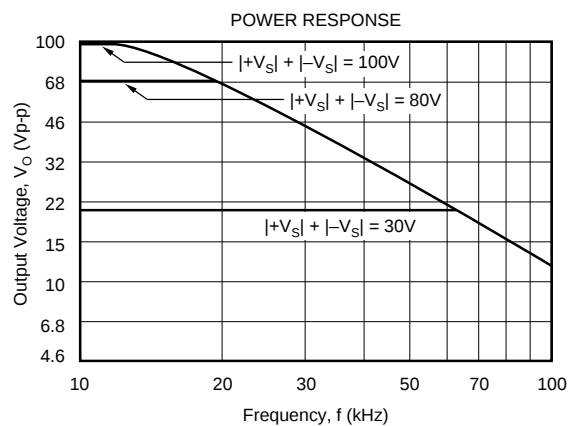
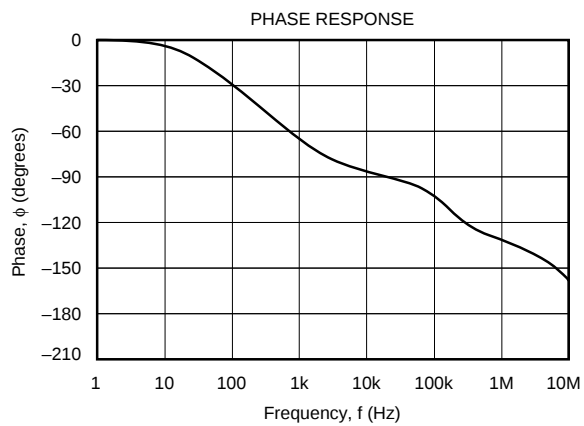
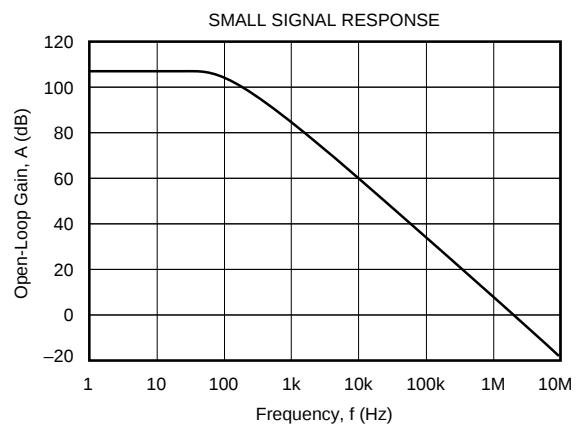
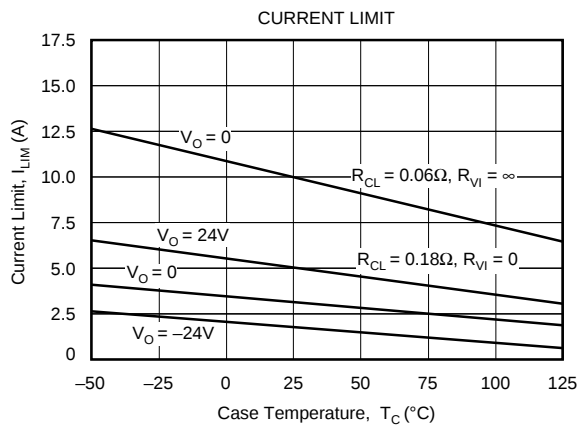
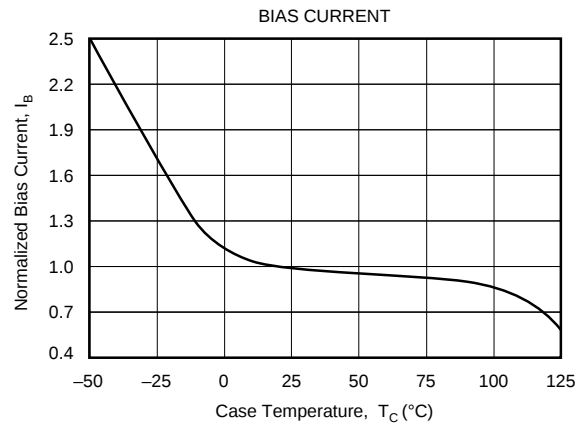
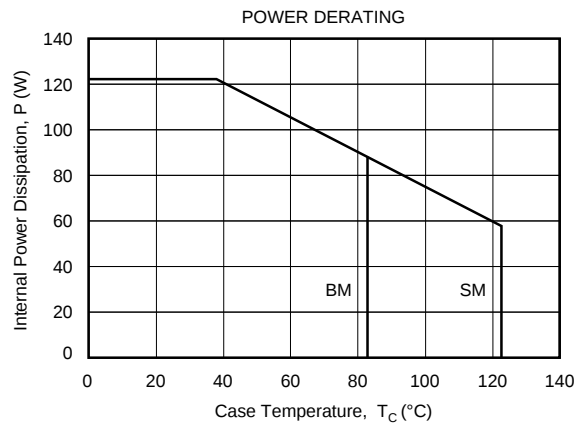
MODEL	PACKAGE	TEMPERATURE RANGE
OPA512BM	8-pin TO-3	–25°C to +85°C
OPA512SM	8-pin TO-3	–55°C to +125°C

MODEL	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾
OPA512BM	8-Pin TO-3	030
OPA512SM	8-Pin TO-3	030

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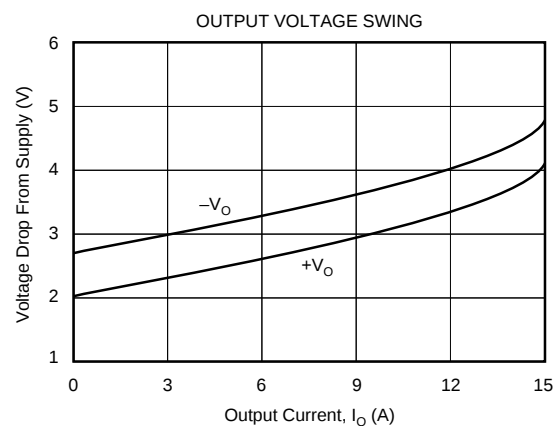
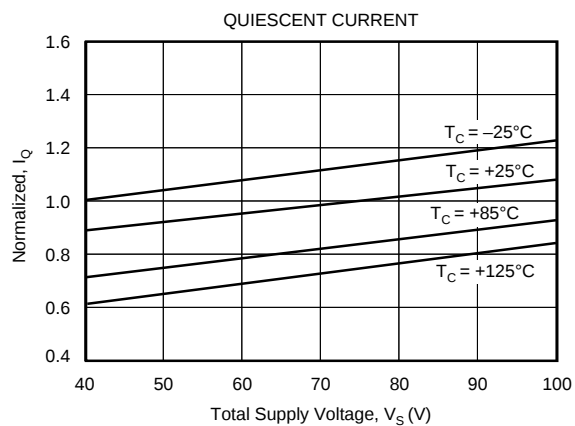
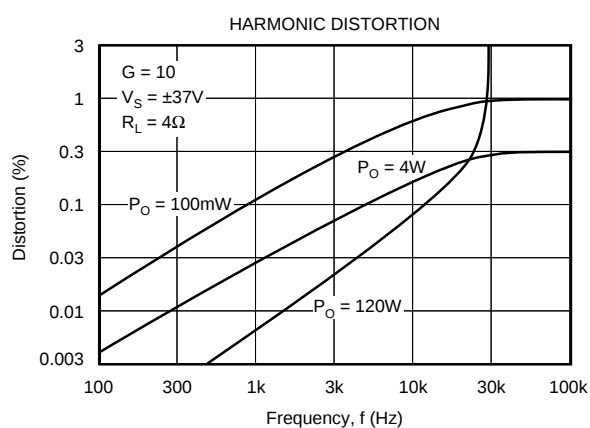
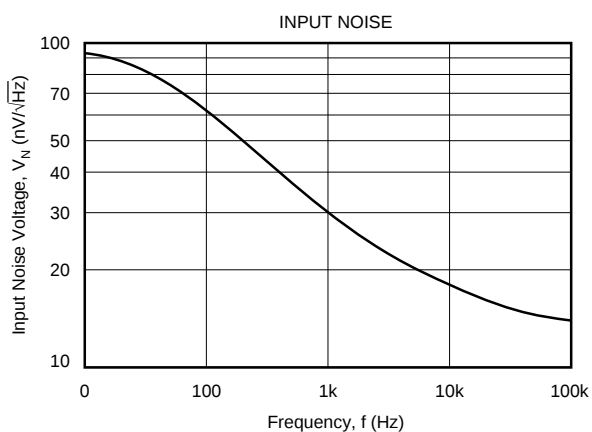
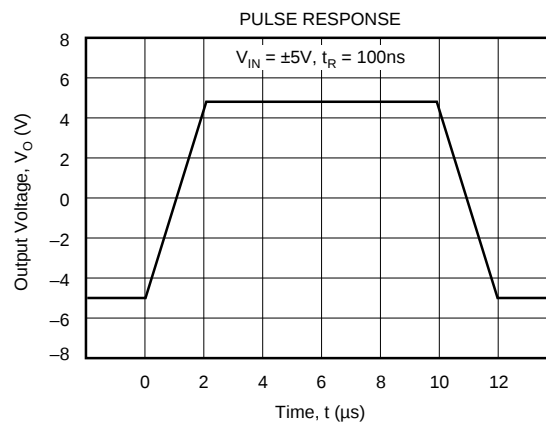
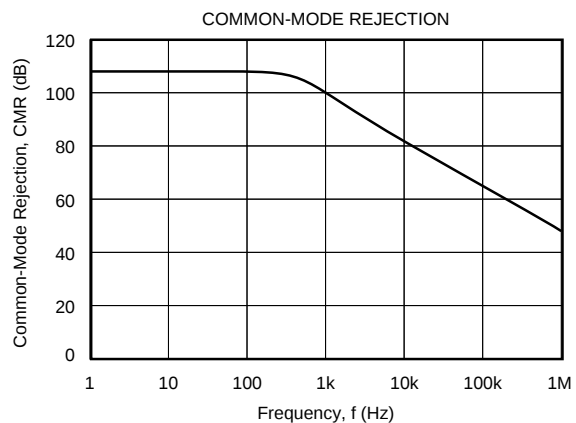
TYPICAL PERFORMANCE CURVES

$T_A = 25^\circ\text{C}$, $V_S = \pm 40\text{VDC}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (CONT)

$T_A = 25^\circ\text{C}$, $V_S = \pm 40\text{VDC}$, unless otherwise noted.



APPLICATIONS INFORMATION

POWER SUPPLIES

Specifications for the OPA512 are based on a nominal operating voltage of $\pm 40\text{V}$. A single power supply or unbalanced supplies may be used as long as the maximum total operating voltage (total of $+V_S$ and $-V_S$) is not greater than 90V (100V for OPA512SM model.)

CURRENT LIMITS

Current limit resistors must be provided for proper operation. Independent positive and negative current limit values may be selected by choice of R_{CL+} and R_{CL-} , respectively. Resistor values are calculated by:

$$R_{CL} = 0.65/I_{LIM} \text{ (amps)} - 0.007$$

This is the nominal current limit value at room temperature. The maximum output current decreases at high temperature as shown in the typical performance curve. Most wire-wound resistors are satisfactory, but some highly inductive types may cause loop stability problems. Be sure to evaluate performance with the actual resistors to be used in production.

HEAT SINKING

Power amplifiers are rated by case temperature (not ambient temperature.) The maximum allowable power dissipation is a function of the case temperature as shown in the power derating curve. Load characteristics, signal conditions, and power supply voltage determine the power dissipated by the amplifier. The case temperature will be determined by the heat sinking conditions. Sufficient heat sinking must be provided to keep the case temperature within safe bounds given the power dissipated and ambient temperature. See Application Bulletin AB-038 for further details.

SAFE OPERATING AREA (SOA)

The safe area plot provides a comprehensive summary of the power handling limitations of a power amplifier, including maximum current, voltage and power as well as the secondary breakdown region (see Figure 1) It shows the allowable output current as a function of the power supply to output voltage differential (voltage across the conducting power device.) See Application Bulletin AB-039 for details on SOA.

VOLTAGE-CURRENT LIMITER CIRCUITRY

The voltage-current (V-I) limiter circuit provides a means to protect the amplifier from SOA damage such as a short circuit to ground, yet allows high output currents to flow

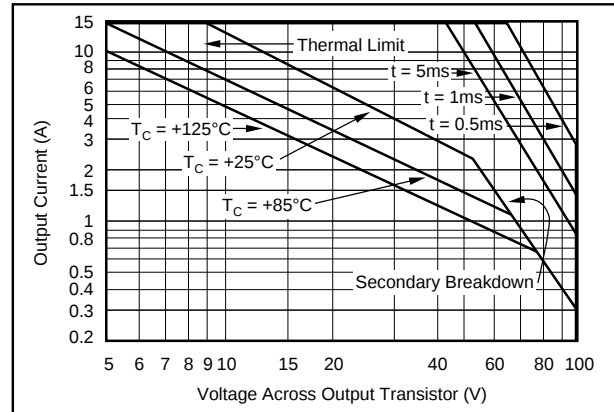


FIGURE 1. Safe Operating Area.

under normal load conditions. Sensing both the output current and the output voltage, this limiter circuit increases the current limit value as the output voltage approaches the power supply voltage (where power dissipation is low.) This type of limiting is achieved by connecting pin 7 through a programming resistor to ground. The V-I limiter circuit is governed by the equation:

$$I_{LIMIT} = \frac{0.65 + \frac{0.28 V_O}{20 + R_{VI}}}{R_{CL} + 0.007}$$

where:

I_{LIMIT} is the maximum current available at a given output voltage.

R_{VI} is the value ($k\Omega$) of the resistor from pin 7 to ground.

R_{CL} is the current limit resistor in ohms.

V_O is the instantaneous output voltage in volts.

Reactive or EMF-generating loads may produce unusual (perhaps undesirable) waveforms with the V-I limit circuit driven into limit. Since current peaks in a reactive load do not align with the output voltage peaks, the output waveform will not appear as a simple voltage-limited waveform. Response of the load to the limiter, in fact, may produce a "backfire" reaction producing unusual output waveforms.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
OPA512BM	NRND	TO-3	LMF	8		TBD	Call TI	Call TI
OPA512SM	NRND	TO-3	LMF	8		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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